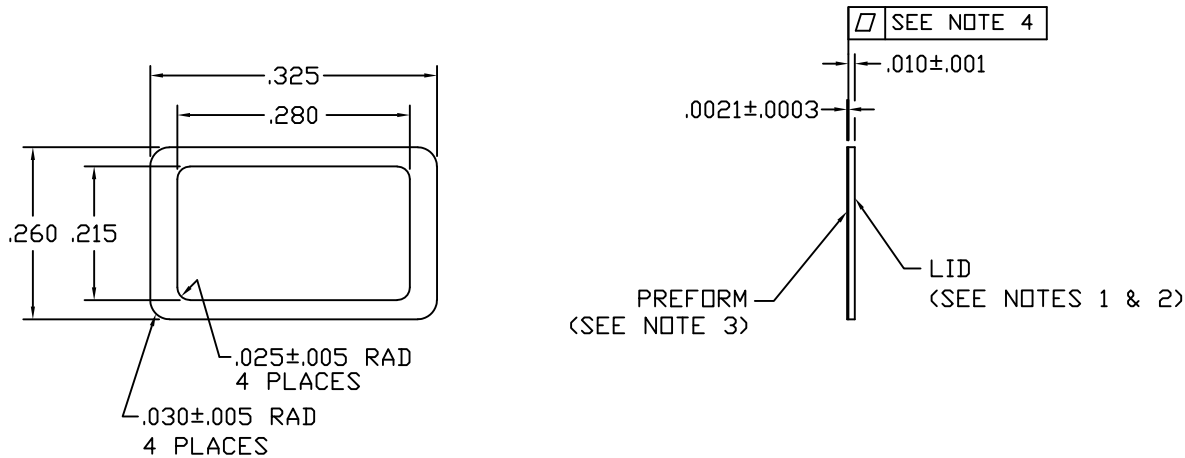


# SSM P/N CL322604



**NOTES**

1. MAT'L : KOVAR OR ALLOY 42
  2. PLATING : 1st LAYER 50/350 MICROINCHES Ni  
 2nd LAYER 25 MICROINCHES MIN. Au  
 3rd LAYER 50/350 MICROINCHES Ni  
 4th LAYER 25 MICROINCHES MIN. Au
- NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.
3. PREFORM - 80%  $\pm 1\%$  Au  
 20% Sn
  4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
  5. TOLERANCES TO BE (XXX) 3 PLACES  $\pm .003$  UNLESS OTHERWISE NOTED

Part Name: CL322604		Description: Hi-Rel Combo Lid	
Part Number: W1266H		Mfg: Materion Corporation	Scale 4 = 1
Spectrum Semiconductor Materials, Inc. 155 Nicholson Lane San Jose, CA 95134 PH: (408) 435-5555 Fax: (408) 435-8226		Approved By: SJO	
		Rev. Date: 12/21/2017	

